# SiA4371EDJ

**Vishay Siliconix** 

www.vishay.com

P-Channel 30 V (D-S) MOSFET

### PowerPAK<sup>®</sup> SC-70-6L Single





Marking code: KD

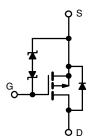
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -10 V	0.045				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.053				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -2.5 V	0.081				
Q <sub>g</sub> typ. (nC)	10.6				
I <sub>D</sub> (A) <sup>a, e</sup>	-9				
Configuration	Single				

#### FEATURES

- TrenchFET<sup>®</sup> power MOSFET
- 100 % R<sub>g</sub> tested
- Thermally enhanced PowerPAK<sup>®</sup> SC-70 package
  - Small footprint area
  - Low on-resistance
- Typical ESD protection: 3000 V (HBM)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Power management for portable and consumer
- Load switch
- Charger switches
- Battery switches



RoHS

COMPLIANT

HALOGEN

P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA4371EDJ-T1-GE3

ABSOLUTE MAXIMUM RATING	<b>S</b> (T <sub>A</sub> = 25 °C, ι	Inless otherwi	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-30	V	
Gate-source voltage		V <sub>GS</sub>	± 12	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-9 e		
	T <sub>C</sub> = 70 °C	1 , Г	-9 e		
	T <sub>A</sub> =25 °C		-6.4 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1 [	-5.1 <sup>b, c</sup>	A	
Pulsed drain current (t = 300 μs)		I <sub>DM</sub>	-20		
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		-9 e		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-2.4 <sup>b, c</sup>		
Maximum power dissipation	T <sub>C</sub> = 25 °C		15.6		
	T <sub>C</sub> = 70 °C		10	14/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.9 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C	1	1.9 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	*0	
Soldering recommendations (peak temperature) c, d			260		

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b, d	t ≤ 5 s	R <sub>thJA</sub>	32	43	°C/W		
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	6	8			

Notes

a. T<sub>C</sub> = 25 °C

b. Surface mounted on 1" x 1" FR4 board

- c. t = 5 s
- d. Maximum under steady state conditions is 80 °C/W

e. Package limited

S21-1125-Rev. A, 22-Nov-2021

1

Document Number: 63160

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•		•		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-24	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μΑ	-	2.2	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-0.6	-	-1.5	V	
Onto any lankana		$V_{DS} = 0 V, V_{GS} = \pm 12 V$	-	-	± 10	1	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$	-	-	± 1	- μA	
Zeve este veltere ducie comont		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1		
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-10		
		V <sub>GS</sub> = -10 V, I <sub>D</sub> = -3.7 A	-	0.034	0.045	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -2 \text{ A}$	-	0.041	0.053		
		$V_{DS} = -2.5 \text{ V}, I_D = -2 \text{ A}$	-	0.068	0.081		
Dynamic <sup>b</sup>	•			<b></b>			
		$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -3.7 \text{ A}$	-	22.8	35	nC	
Total gate charge	Qg	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -3.7 A	-	10.6	16		
Gate-source charge	Q <sub>as</sub>		-	1.7	-		
Gate-drain charge	Q <sub>ad</sub>		-	2.6	-		
Gate resistance	R <sub>q</sub>	f = 1 MHz	2.2	11	22	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	28	42	-	
Rise time	t <sub>r</sub>	V <sub>DD</sub> = -15 V, R <sub>I</sub> = 5.2 Ω, I <sub>D</sub> ≅ -2.9 A,	-	65	98		
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 3.2 \text{ S}, \text{ R}_{\text{g}} = -2.8 \text{ A},$	-	47	71		
Fall time	tf		-	62	93		
Turn-on delay time	t <sub>d(on)</sub>		-	7	14	ns	
Rise time	t <sub>r</sub>	V <sub>DD</sub> = -15 V, R <sub>I</sub> = 5.2 Ω, I <sub>D</sub> ≅ -2.9 A,	-	8	16	-	
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	52	78		
Fall time	t <sub>f</sub>		-	52	78		
Drain-Source Body Diode Characterist	cs					1	
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C -	-	-1.4	Ι.		
Pulse diode forward current	I <sub>SM</sub>	-	-	-	-20	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -2.9 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	13	20	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -2.9 A, di/dt = 100 A/µs,	-	6	12	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	9	-	1	
Reverse recovery rise time	t <sub>b</sub>		_	4	_	ns	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

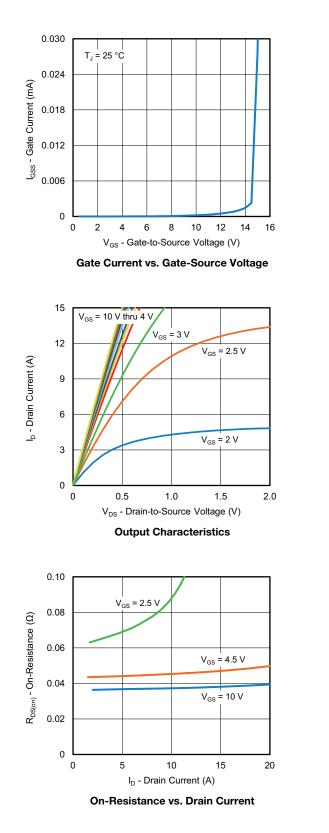
b. Guaranteed by design, not subject to production testing

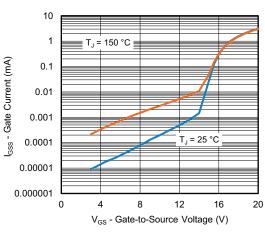
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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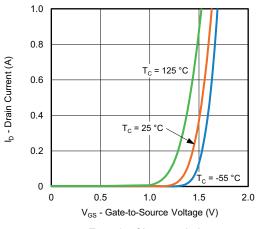


## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

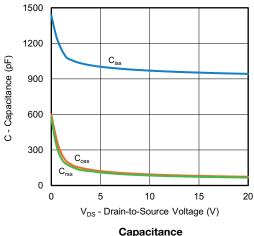




Gate Current vs. Gate-Source Voltage



**Transfer Characteristics** 



Capacitance

S21-1125-Rev. A, 22-Nov-2021

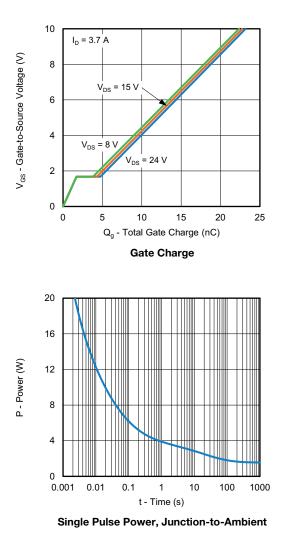
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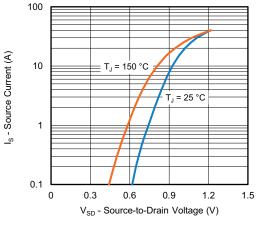
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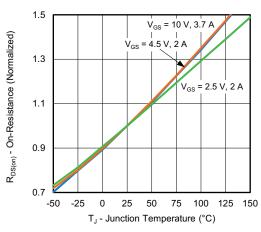


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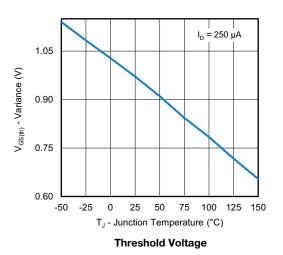


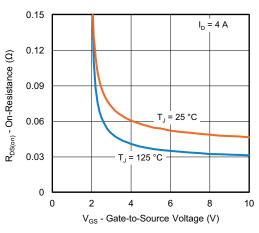


Source-Drain Diode Forward Voltage



**On-Resistance vs. Junction Temperature** 





On-Resistance vs. Gate-to-Source Voltage

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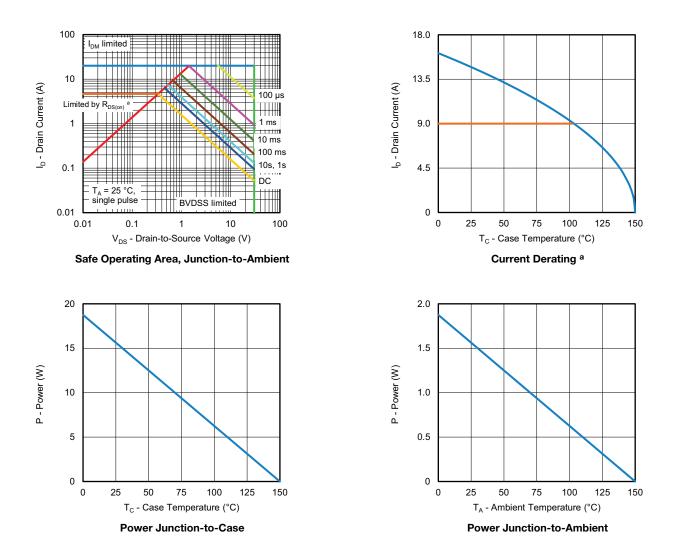
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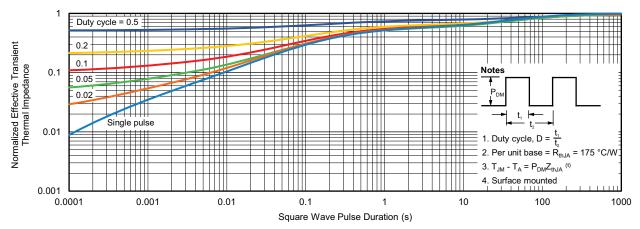
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

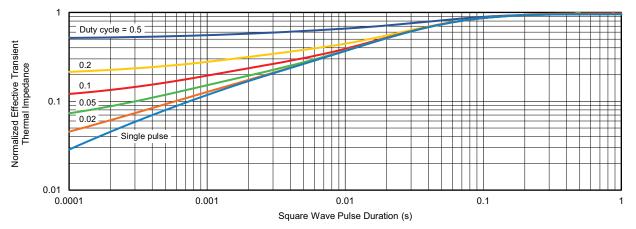
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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